

Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Single phase, half wave, 60Hz, resistive or inductive load.
For capacitive load, derate current by 20%.

Characteristic	Symbol	SBG 3030CT	SBG 3040CT	SBG 3045CT	Unit
Peak Repetitive Reverse Voltage	V _{RRM}				
Working Peak Reverse Voltage	V _{RWM}	30	40	45	V
DC Blocking Voltage (Note 2)	V _R				
RMS Reverse Voltage	V _{R(RMS)}	21	28	32	V
Average Rectified Output Current @ T _C = +100°C	I _O		30		A
Non-Repetitive Peak Forward Surge Current	I _{FSM}		250		A
8.3ms Single Half Sine-wave Superimposed On Rated Load					

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Typical Thermal Resistance Junction to Case (Note 3)	R _{θJC}	1.5	°C/W
Operating Temperature Range	T _J	-55 to +125	°C
Storage Temperature Range	T _{STG}	-55 to +150	°C

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Forward Voltage, Per Element @ I _F = 15A, T _C = +25°C	V _{FM}	0.55	V
Peak Reverse Current @ T _J = +25°C	I _{RM}	1.0	mA
at Rated DC Blocking Voltage (Note 2) @ T _J = +100°C		75	
Typical Total Capacitance (Note 4)	C _T	420	pF

- Notes:
2. Short duration pulse test used to minimize self-heating effect.
 3. Thermal resistance junction to case mounted on heatsink.
 4. Measured at 1.0MHz and applied reverse voltage of 4.0V DC and per element.

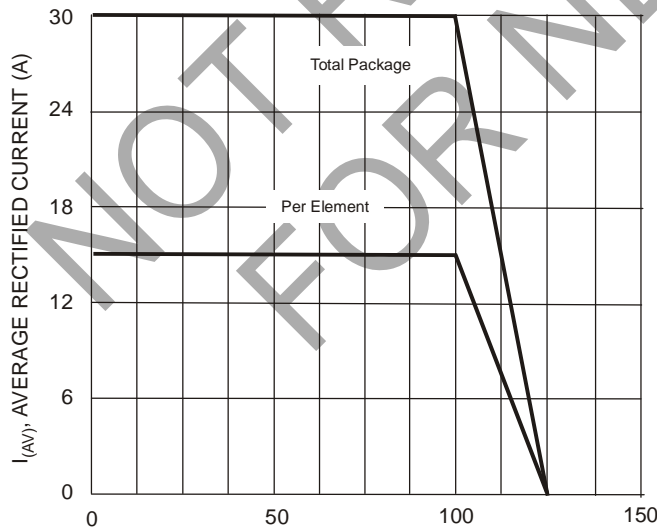


Fig. 1 Forward Derating Curve

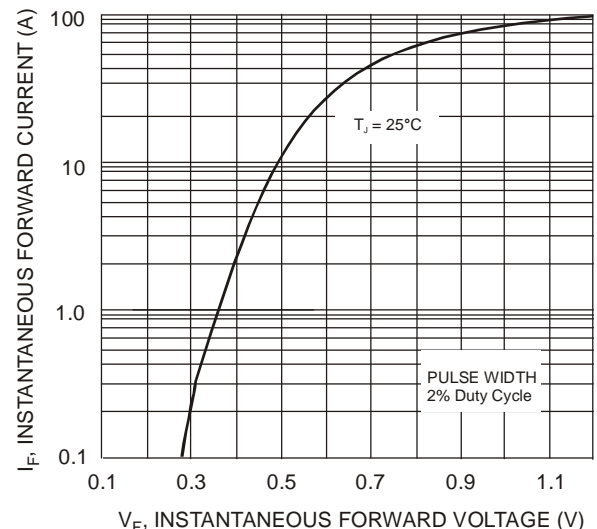
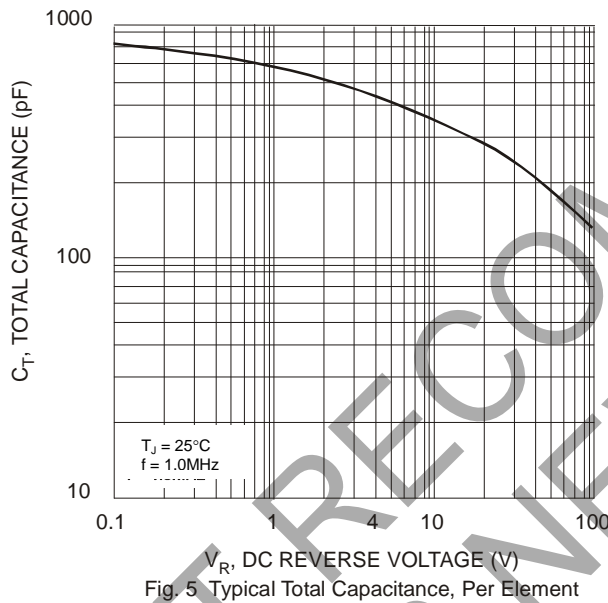
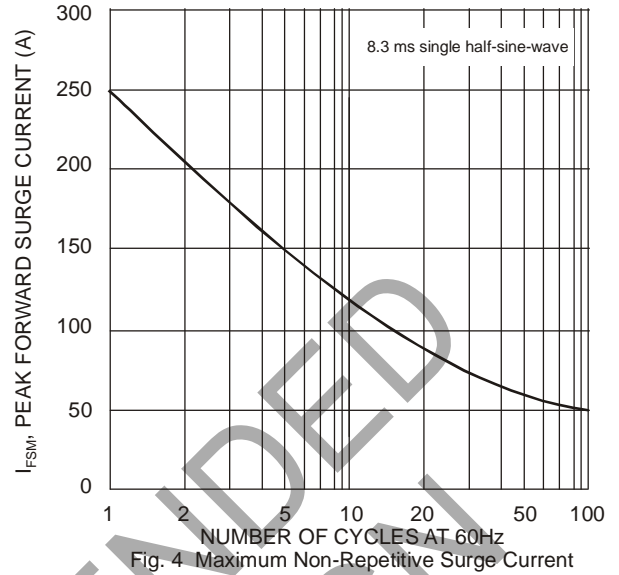
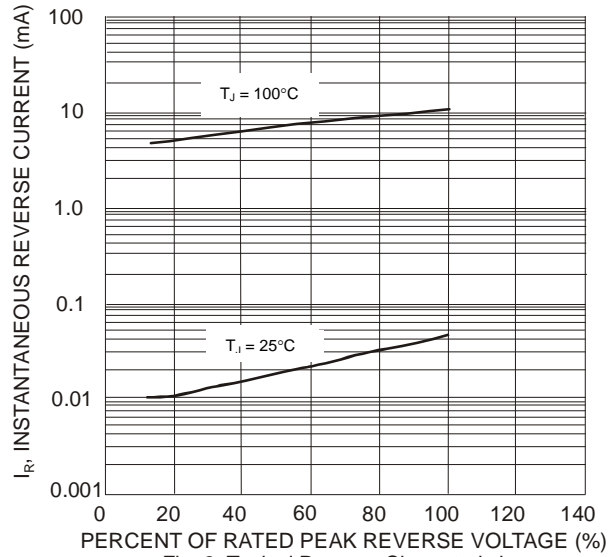


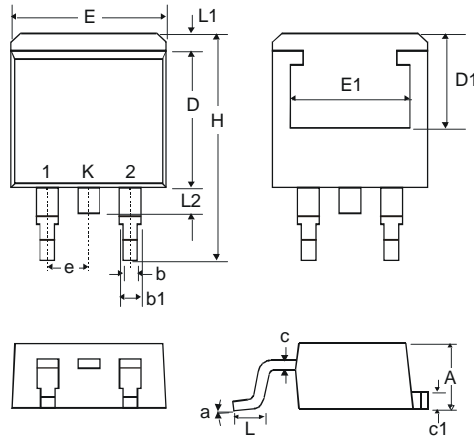
Fig. 2 Typical Forward Characteristics, Per Element



Package Outline Dimensions

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

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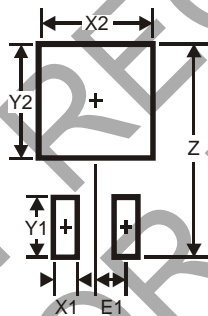


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Dim	Min	Max
A	4.07	4.82
b	0.51	0.99
b1	1.15	1.77
c	0.356	0.58
c1	1.143	1.65
D	8.39	9.65
D1	6.55	—
E	9.66	10.66
E1	6.23	—
e	2.54 Typ	
H	14.61	15.87
L	1.78	2.79
L1	—	1.67
L2	—	1.77
a	0°	8°
All Dimensions in mm		

Suggested Pad Layout

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

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Dimensions	Value (in mm)
Z	16.9
X1	1.1
X2	10.8
Y1	3.5
Y2	7.01
E1	2.5

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